## Data sheet 6ES7514-2SN03-0AB0



SIMATIC DP, CPU 1514SP F-2 PN for ET 200SP, central processing unit with work memory 900 KB for program and 3.5 MB for data, 1st interface: PROFINET IRT with 2-port switch, 2nd interface: PROFINET RT, 6 ns bit performance, SIMATIC Memory Card required, BusAdapter required for 1st interface \*\*\*\* approvals and certificates according to ID 109818872 at support.industry.siemens.com to be observed! \*\*\*\*

General information	
Product type designation	CPU 1514SP F-2 PN
HW functional status	FS01
Firmware version	V3.0
FW update possible	Yes
Product function	
<ul> <li>I&amp;M data</li> </ul>	Yes; I&M0 to I&M3
<ul> <li>Module swapping during operation (hot swapping)</li> </ul>	Yes; Multi-hot swapping
• Isochronous mode	Yes; only with PROFINET; with minimum OB $6x$ cycle of $375~\mu s$
Engineering with	
<ul> <li>STEP 7 TIA Portal configurable/integrated from version</li> </ul>	V18 (FW V3.0)
Configuration control	
via dataset	Yes
Control elements	
Mode selector switch	1
Supply voltage	
Rated value (DC)	24 V
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
<ul> <li>Mains/voltage failure stored energy time</li> </ul>	10 ms
Input current	
Current consumption (rated value)	0.51 A
Current consumption, max.	0.7 A
Inrush current, max.	1.34 A; Rated value
l²t	0.3 A²-s
Power	
Infeed power to the backplane bus	8.05 W
Power loss	
Power loss, typ.	6.5 W
Memory	
Number of slots for SIMATIC memory card	1
SIMATIC memory card required	Yes
Work memory	
<ul><li>integrated (for program)</li></ul>	900 kbyte
integrated (for data)	3.5 Mbyte
Load memory	
<ul> <li>Plug-in (SIMATIC Memory Card), max.</li> </ul>	32 Gbyte
Backup	

maintenance-free	Yes
CPU processing times	
for bit operations, typ.	6 ns
for word operations, typ.	7 ns
for fixed point arithmetic, typ.	9 ns
for floating point arithmetic, typ.	37 ns
CPU-blocks	
Number of elements (total)	8 000; Blocks (OB, FB, FC, DB) and UDTs
DB	
Number range	1 60 999; subdivided into: number range that can be used by the user: 1 59 999, and number range of DBs created via SFC 86: 60 000 60 999
Size, max.	3.5 Mbyte; For DBs with absolute addressing, the max. size is 64 KB
FB	
Number range	0 65 535
• Size, max.	900 kbyte
FC Number and the	0 05 505
Number range     Size max	0 65 535
Size, max.  OB	900 kbyte
	900 khyte
<ul><li>Size, max.</li><li>Number of free cycle OBs</li></ul>	900 kbyte 100
Number of fime alarm OBs	20
Number of time alarm OBs     Number of delay alarm OBs	20
•	
Number of cyclic interrupt OBs     Number of process clarm OBs	20; With minimum OB 3x cycle of 250 μs
Number of process alarm OBs	50
Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	1
Number of technology synchronous alarm OBs	2
<ul> <li>Number of startup OBs</li> </ul>	100
<ul> <li>Number of asynchronous error OBs</li> </ul>	4
<ul> <li>Number of synchronous error OBs</li> </ul>	2
Number of diagnostic alarm OBs	1
Nesting depth	
per priority class	24; Up to 8 possible for F-blocks
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
• Number	Any (only limited by the main memory)
Retentivity	
— adjustable	Yes
S7 times	
• Number	2 048
Retentivity	
— adjustable	Yes
IEC timer	
Number	Any (only limited by the main memory)
Number Retentivity	Any (only limited by the main memory)
Retentivity — adjustable	Any (only limited by the main memory)  Yes
Retentivity	
Retentivity — adjustable	
Retentivity — adjustable  Data areas and their retentivity	Yes 512 kbyte; In total; available retentive memory for bit memories, timers,
Retentivity — adjustable  Data areas and their retentivity  Retentive data area (incl. timers, counters, flags), max.	Yes 512 kbyte; In total; available retentive memory for bit memories, timers,
Retentivity — adjustable  Data areas and their retentivity  Retentive data area (incl. timers, counters, flags), max.  Flag	Yes  512 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 472 KB
Retentivity — adjustable  Data areas and their retentivity  Retentive data area (incl. timers, counters, flags), max.  Flag  • Size, max.	Yes  512 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 472 KB  16 kbyte
Retentivity — adjustable  Data areas and their retentivity  Retentive data area (incl. timers, counters, flags), max.  Flag  • Size, max. • Number of clock memories	Yes  512 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 472 KB  16 kbyte
Retentivity — adjustable  Data areas and their retentivity  Retentive data area (incl. timers, counters, flags), max.  Flag  • Size, max. • Number of clock memories  Data blocks	Yes  512 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 472 KB  16 kbyte 8; 8 clock memory bit, grouped into one clock memory byte
Retentivity — adjustable  Data areas and their retentivity  Retentive data area (incl. timers, counters, flags), max.  Flag  • Size, max. • Number of clock memories  Data blocks • Retentivity adjustable	Yes  512 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 472 KB  16 kbyte 8; 8 clock memory bit, grouped into one clock memory byte

<ul> <li>per priority class, max.</li> <li>Address area</li> <li>Number of IO modules</li> <li>8 192; max. number of modules / submodules</li> <li>I/O address area</li> <li>Inputs</li> <li>Outputs</li> <li>Outputs are in the process image</li> <li>Per integrated IO subsystem</li> <li>Inputs (volume)</li> <li>A kbyte</li> <li>Outputs (volume)</li> <li>B kbyte</li> <li>Per CM/CP</li> <li>Inputs (volume)</li> <li>B kbyte</li> <li>Outputs (volume)</li> <li>B kbyte</li> <li>Subprocess images</li> <li>Number of subprocess images, max.</li> <li>Address space per module</li> </ul>	
Number of IO modules  I/O address area  I/O address area  Inputs  Outputs  Outputs  Per integrated IO subsystem  — Inputs (volume)  Per CM/CP  — Inputs (volume)  — Outputs (volume)  — Outputs (volume)  B kbyte  Per CM/CP  — Inputs (volume)  — Outputs (volume)  B kbyte  8 kbyte  Subprocess images  Number of subprocess images, max.  32	
I/O address area  ● Inputs  ● Outputs  ● Outputs  Outputs (volume)  — Outputs (volume)  — Inputs (volume)  — Inputs (volume)  — Inputs (volume)  — Outputs (volume)  — Outputs (volume)  — S kbyte  Per CM/CP  — Inputs (volume)  — Outputs (volume)  8 kbyte  9 kbyte  Subprocess images  ● Number of subprocess images, max.  32 kbyte; All inputs are in the process image  8 kbyte; All outputs are in the process image  8 kbyte  8 kbyte	
<ul> <li>Inputs</li> <li>Outputs</li> <li>Outputs</li> <li>32 kbyte; All inputs are in the process image</li> <li>Outputs are in the process image</li> <li>per integrated IO subsystem</li> <li>— Inputs (volume)</li> <li>— Outputs (volume)</li> <li>B kbyte</li> <li>— Outputs (volume)</li> <li>— Inputs (volume)</li> <li>— Inputs (volume)</li> <li>— Outputs (volume)</li> <li>— Outputs (volume)</li> <li>B kbyte</li> <li>Subprocess images</li> <li>Number of subprocess images, max.</li> <li>32</li> </ul>	
● Outputs  per integrated IO subsystem  — Inputs (volume) — Outputs (volume) 8 kbyte  — Outputs (volume) 8 kbyte  per CM/CP — Inputs (volume) 8 kbyte  — Outputs (volume) 8 kbyte  Subprocess images ● Number of subprocess images, max.  32 kbyte; All outputs are in the process image  8 kbyte  8 kbyte  9 kbyte	
per integrated IO subsystem  — Inputs (volume)	
<ul> <li>— Inputs (volume)</li> <li>— Outputs (volume)</li> <li>8 kbyte</li> <li>per CM/CP</li> <li>— Inputs (volume)</li> <li>— Outputs (volume)</li> <li>8 kbyte</li> <li>— Outputs (volume)</li> <li>8 kbyte</li> <li>Subprocess images</li> <li>Number of subprocess images, max.</li> <li>32</li> </ul>	
— Outputs (volume) 8 kbyte  per CM/CP  — Inputs (volume) 8 kbyte  — Outputs (volume) 8 kbyte  Subprocess images  ● Number of subprocess images, max. 32	
per CM/CP — Inputs (volume) 8 kbyte — Outputs (volume) 8 kbyte  Subprocess images  Number of subprocess images, max. 32	
— Inputs (volume) 8 kbyte  — Outputs (volume) 8 kbyte  Subprocess images  ● Number of subprocess images, max. 32	
— Outputs (volume) 8 kbyte  Subprocess images  ● Number of subprocess images, max. 32	
Subprocess images  • Number of subprocess images, max.  32	
Number of subprocess images, max.     32	
Address space per module	
Address space per module, max.     288 byte; For input and output data respectively	
Address space per station	
<ul> <li>Address space per station, max.</li> <li>2 560 byte; for central inputs and outputs; depending on configuration bytes for ET 200SP modules + 512 bytes for ET 200AL modules</li> </ul>	n; 2 048
Hardware configuration	
Number of distributed IO systems  64; A distributed I/O system is characterized not only by the integrati distributed I/O via PROFINET or PROFIBUS communication module by the connection of I/O via AS-i master modules or links (e.g. IE/PB	s, but also
Number of DP masters	
• Via CM 1	
Number of IO Controllers	
• integrated 2	
• Via CM 0	
Rack	
• Modules per rack, max.  80; CPU + 64 modules + server module (mounting width max. 1 m) - 200AL modules	+ 16 ET
Quantity of operable ET 200SP modules, max.	
Quantity of operable ET 200AL modules, max.	
• Number of lines, max.	
PtP CM	
<ul> <li>Number of PtP CMs</li> <li>the number of connectable PtP CMs is only limited by the number of slots</li> </ul>	available
Time of day	
Clock	
• Type Hardware clock	
Backup time     6 wk; At 40 °C ambient temperature, typically	
• Deviation per day, max. 10 s; Typ.: 2 s	
Operating hours counter	
• Number 16	
Clock synchronization	
• supported Yes	
• to DP, master  Yes; Via CM DP module	
• to DP, slave  • to DP, slave  Yes; Via CM DP module	
• in AS, master  Yes	
• in AS, slave  • in AS, slave  Yes	
• on Ethernet via NTP  Yes	
Interfaces  Number of PROFINET interfaces	
Number of PROFINET interfaces 2	
Number of PROFIBUS interfaces 1; Via CM DP module	
Optical interface No	
1. Interface	
1. Interface Interface types	
Interface types	
Interface types  • RJ 45 (Ethernet)  Yes; X1 P1 and X1 P2 via BusAdapter BA 2x RJ45	
Interface types  • RJ 45 (Ethernet)  • Number of ports  Yes; X1 P1 and X1 P2 via BusAdapter BA 2x RJ45  2; via BusAdapter	

Yes; IPv4 • IP protocol • PROFINET IO Controller Yes PROFINET IO Device Yes • SIMATIC communication Yes • Open IE communication Yes; Optionally also encrypted Web server Yes Media redundancy Yes **PROFINET IO Controller** Services - PG/OP communication Yes Isochronous mode - Direct data exchange Yes; Requirement: IRT and isochronous mode (MRPD optional) - IRT Yes - PROFlenergy Yes; per user program Yes; Max. 32 PROFINET devices - Prioritized startup - Number of connectable IO Devices, max. 256; In total, up to 1 000 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET - Of which IO devices with IRT, max. - Number of connectable IO Devices for RT, max. 256 - of which in line, max. 256 - Number of IO Devices that can be simultaneously 8; in total across all interfaces activated/deactivated, max. - Number of IO Devices per tool, max. 8 - Updating times The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data Update time for IRT  $250~\mu s$  to 4 ms; Note: In the case of IRT with isochronous mode, the minimum — for send cycle of 250 µs update time of 375  $\mu s$  of the isochronous OB is decisive — for send cycle of 500 µs 500 µs to 8 ms - for send cycle of 1 ms 1 ms to 16 ms - for send cycle of 2 ms 2 ms to 32 ms - for send cycle of 4 ms 4 ms to 64 ms — With IRT and parameterization of "odd" send cycles Update time = set "odd" send clock (any multiple of 125  $\mu$ s: 375  $\mu$ s, 625  $\mu$ s ... 3 Update time for RT 250 µs to 128 ms — for send cycle of 250  $\mu s$ - for send cycle of 500 μs 500 µs to 256 ms — for send cycle of 1 ms 1 ms to 512 ms - for send cycle of 2 ms 2 ms to 512 ms - for send cycle of 4 ms 4 ms to 512 ms **PROFINET IO Device** Services - PG/OP communication Yes - Isochronous mode No — IRT Yes — PROFlenergy Yes; per user program - Shared device Yes - Number of IO Controllers with shared device, max. activation/deactivation of I-devices Yes; per user program - Asset management record Yes; per user program Interface types • RJ 45 (Ethernet) Yes; X2 Number of ports 1 • integrated switch Nο Protocols Yes: IPv4 • IP protocol • PROFINET IO Controller Yes • PROFINET IO Device Yes Yes • SIMATIC communication • Open IE communication Yes; Optionally also encrypted

Web server	Yes
Media redundancy	No
PROFINET IO Controller	NO
Services	
— PG/OP communication	Yes
— Isochronous mode	No
	No
Direct data exchange  IRT	No
PROFlenergy      Prioritized startup	Yes; per user program
·	No
Number of connectable IO Devices, max.	32; In total, up to 1 000 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET 32
<ul><li>— Number of connectable IO Devices for RT, max.</li><li>— of which in line, max.</li></ul>	32
•	
Number of IO Devices that can be simultaneously activated/deactivated, max.	8; in total across all interfaces
Number of IO Devices per tool, max.	
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for RT	
— for send cycle of 1 ms	1 ms to 512 ms
PROFINET IO Device	
Services	
— PG/OP communication	Yes
— Isochronous mode	No
— IRT	No
— PROFlenergy	Yes; per user program
Prioritized startup	No
— Shared device	Yes
<ul> <li>Number of IO Controllers with shared device, max.</li> </ul>	4
<ul> <li>activation/deactivation of I-devices</li> </ul>	Yes; per user program
Asset management record	Yes; per user program
3. Interface	
Interface types	
• RS 485	Yes; Via CM DP module
Number of ports	1
Protocols	
PROFIBUS DP master	Yes
PROFIBUS DP slave	Yes
SIMATIC communication	
PROFIBUS DP master	Yes
	49: Of which 4 each recorded for ES and UMI
<ul><li>Number of connections, max.</li><li>Number of DP slaves, max.</li></ul>	48; Of which 4 each reserved for ES and HMI  125; In total, up to 1 000 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET
Services	
— PG/OP communication	Yes
— Equidistance	No
Light Statice  Isochronous mode	No
Activation/deactivation of DP slaves	Yes
Interface types	
RJ 45 (Ethernet)	Voc
• 100 Mbps	Yes
Autoregotiation	Yes
Autocrossing	Yes
Industrial Ethernet status LED	Yes
RS 485	40.48.89
Transmission rate, max.	12 Mbit/s
Protocols	
	Yes; V2.4 / V2.6
PROFIsafe	100, V2.47 V2.0
PROFIsafe Number of connections	192; via integrated interfaces of the CPU and connected CPs / CMs

<ul> <li>Number of connections reserved for ES/HMI/web</li> </ul>	10
<ul> <li>Number of connections via integrated interfaces</li> </ul>	128
<ul> <li>Number of connections per CP/CM</li> </ul>	32
<ul> <li>Number of S7 routing paths</li> </ul>	16
Redundancy mode	
H-Sync forwarding	Yes
Media redundancy	
— Media redundancy	Yes; only via BusAdapter
— MRP	Yes; MRP Automanager according to IEC 62439-2 Edition 2.0, MRP Manager; MRP Client
<ul> <li>MRP interconnection, supported</li> </ul>	Yes; as MRP ring node according to IEC 62439-2 Edition 3.0
— MRPD	Yes; Requirement: IRT
<ul> <li>Switchover time on line break, typ.</li> </ul>	200 ms; For MRP, bumpless for MRPD
<ul> <li>Number of stations in the ring, max.</li> </ul>	50
SIMATIC communication	
PG/OP communication	Yes; encryption with TLS V1.3 pre-selected
S7 routing	Yes
Data record routing	Yes
S7 communication, as server	Yes
S7 communication, as client	Yes
User data per job, max.	See online help (S7 communication, user data size)
Open IE communication	222 2 15. (5. 55
• TCP/IP	Yes
— Data length, max.	64 kbyte
several passive connections per port, supported	Yes
ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 kbyte; 1 472 bytes for UDP broadcast
— UDP multicast	Yes; max. 118 multicast circuits
• DHCP	Yes
• DNS	Yes
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Encryption	Yes; Optional
Web server	
• HTTP	Yes; Standard and user pages
• HTTPS	Yes; Standard and user pages
OPC UA	
<ul> <li>Runtime license required</li> </ul>	Yes; "Medium" license required
OPC UA Client	Yes; Data Access (registered Read/Write), Method Call
<ul> <li>Application authentication</li> </ul>	Yes
— Security policies	Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
<ul> <li>User authentication</li> </ul>	"anonymous" or by user name & password
<ul> <li>Number of connections, max.</li> </ul>	10
<ul> <li>Number of nodes of the client interfaces, recommended max.</li> </ul>	2 000
<ul> <li>Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max.</li> </ul>	300
Number of elements for one call of OPC_UA_NameSpaceGetIndexList, max.	20
Number of elements for one call of OPC_UA_MethodGetHandleList, max.	100
<ul> <li>Number of simultaneous calls of the client instructions for session management, per connection, max.</li> </ul>	1
<ul> <li>Number of simultaneous calls of the client instructions for data access, per connection, max.</li> </ul>	5
<ul> <li>Number of registerable nodes, max.</li> </ul>	5 000
<ul> <li>Number of registerable nodes, max.</li> <li>Number of registerable method calls of OPC_UA_MethodCall, max.</li> </ul>	5 000

<ul> <li>Number of inputs/outputs when calling</li> <li>OPC UA MethodCall, max.</li> </ul>	20
OPC UA Server	Yes; Data Access (Read, Write, Subscribe), Method Call, Alarms & Condition (A&C), Custom Address Space
<ul> <li>Application authentication</li> </ul>	Yes
Security policies	available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256, Aes128Sha256RsaOaep, Aes256Sha256RsaPss
— User authentication	"anonymous" or by user name & password
<ul> <li>— GDS support (certificate management)</li> </ul>	Yes
— Number of sessions, max.	48
Number of accessible variables, max.	100 000
Number of registerable nodes, max.	20 000
Number of subscriptions per session, max.	50
— Sampling interval, min.	100 ms
Publishing interval, min.	100 ms
Number of server methods, max.	50
Number of server methods, max.      Number of inputs/outputs per server method, max.	20
Number of monitored items, recommended max.	4 000; for 1 s sampling interval and 1 s send interval
Number of server interfaces, max.	10 of each "Server interfaces" / "Companion specification" type and 20 of the type "Reference namespace"
<ul> <li>Number of nodes for user-defined server interfaces, max.</li> </ul>	30 000
Alarms and Conditions	Yes
Number of program alarms	200
Number of alarms for system diagnostics	100
Further protocols	
MODBUS	Yes; MODBUS TCP
S7 message functions	166, 1165266 161
Number of login stations for message functions, max.	64
Program alarms	Yes
Number of configurable program messages, max.	10 000; Program messages are generated by the "Program_Alarm" block,
	ProDiag or GRAPH  5 000
Number of loadable program messages in RUN, max.	3 000
Number of simultaneously active program alarms	1 000
Number of program alarms	1 000
Number of alarms for system diagnostics	200
Number of alarms for motion technology objects	160
Test commissioning functions	
Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 8 engineering systems
Status block	Yes; Up to 8 simultaneously (in total across all ES clients)
Single step	No
Number of breakpoints	8
Status/control	
Status/control variable	Yes; without fail-safe
• Variables	inputs/outputs, bit memories, DBs, peripheral I/Os (without fail-safe), times, counters
<ul> <li>Number of variables, max.</li> </ul>	
<ul><li>of which status variables, max.</li></ul>	200; per job
— of which control variables, max.	200; per job
Forcing	
<ul><li>Forcing</li></ul>	Yes; without fail-safe
<ul> <li>Forcing, variables</li> </ul>	peripheral inputs/outputs (without fail-safe)
Number of variables, max.	200
Diagnostic buffer	
• present	Yes
<ul> <li>Number of entries, max.</li> </ul>	3 200
— of which powerfail-proof	500
Traces	
Number of configurable Traces	4; Up to 512 KB of data per trace are possible
Interrupts/diagnostics/status information	
Diagnostics indication LED	
RUN/STOP LED	Yes
• ERROR LED	Yes

MAINT LED	Yes
<ul> <li>Monitoring of the supply voltage (PWR-LED)</li> </ul>	Yes
Connection display LINK TX/RX	Yes
Supported technology objects	
Motion Control	Yes; Note: The number of technology objects affects the cycle time of the PLC program; selection guide via the TIA Selection Tool
<ul> <li>Number of available Motion Control resources for technology objects</li> </ul>	2 400
<ul> <li>Required Motion Control resources</li> </ul>	
<ul> <li>per speed-controlled axis</li> </ul>	40
<ul> <li>per positioning axis</li> </ul>	80
— per synchronous axis	160
— per external encoder	80
— per output cam	20
— per cam track	160
— per probe	40
<ul> <li>Positioning axis</li> </ul>	
<ul> <li>Number of positioning axes at motion control cycle of 4 ms (typical value)</li> </ul>	11
<ul> <li>Number of positioning axes at motion control cycle of 8 ms (typical value)</li> </ul>	20
Controller	
PID_Compact	Yes; Universal PID controller with integrated optimization
PID_3Step	Yes; PID controller with integrated optimization for valves
PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	
High-speed counter	Yes
Standards, approvals, certificates	
Highest safety class achievable in safety mode	
Performance level according to ISO 13849-1	PLe
SIL acc. to IEC 61508	SIL 3
Probability of failure (for service life of 20 years and repair time	e of 100 hours)
<ul> <li>Low demand mode: PFDavg in accordance with SIL3</li> </ul>	< 2.00E-05
<ul> <li>High demand/continuous mode: PFH in accordance with SIL3</li> </ul>	< 1.00E-09
Ambient conditions	
Ambient conditions	
Ambient conditions  Ambient temperature during operation	
	-30 °C; No condensation
Ambient temperature during operation	-30 °C; No condensation 60 °C
Ambient temperature during operation  • horizontal installation, min.	
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.	60 °C
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.	60 °C -30 °C; No condensation
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.	60 °C -30 °C; No condensation
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level	60 °C -30 °C; No condensation 50 °C
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.	60 °C -30 °C; No condensation 50 °C
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header	60 °C -30 °C; No condensation 50 °C
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header	60 °C -30 °C; No condensation 50 °C
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD  — FBD  — STL	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD  — FBD  — STL  — SCL	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD  — FBD  — STL  — SCL  — GRAPH	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes
Ambient temperature during operation  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Altitude during operation relating to sea level • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — GRAPH  Know-how protection • User program protection/password protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes
Ambient temperature during operation  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Altitude during operation relating to sea level • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — GRAPH  Know-how protection • User program protection/password protection • Copy protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD  — FBD  — STL  — SCL  — GRAPH  Know-how protection  • User program protection/password protection  • Copy protection  • Block protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD  — FBD — STL — SCL — GRAPH  Know-how protection  • User program protection/password protection  • Copy protection  • Block protection  Access protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes Yes Yes
Ambient temperature during operation  • horizontal installation, min.  • horizontal installation, max.  • vertical installation, min.  • vertical installation, max.  Altitude during operation relating to sea level  • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD  — FBD — STL — SCL — GRAPH  Know-how protection  • User program protection/password protection  • Copy protection  • Block protection  Access protection  • protection of confidential configuration data	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes
Ambient temperature during operation  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Altitude during operation relating to sea level • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — GRAPH  Know-how protection • User program protection/password protection • Copy protection • Block protection  Access protection  • protection of confidential configuration data • Protection level: Write protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes Yes Yes Yes Yes Yes
Ambient temperature during operation  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Altitude during operation relating to sea level • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — GRAPH  Know-how protection  • User program protection/password protection • Copy protection • Block protection  Access protection  • protection of confidential configuration data • Protection level: Write protection  • Protection level: Read/write protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
Ambient temperature during operation  • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.  Altitude during operation relating to sea level • Installation altitude above sea level, max.  configuration / header  configuration / programming / header  Programming language  — LAD — FBD — STL — SCL — GRAPH  Know-how protection • User program protection/password protection • Copy protection • Block protection  Access protection  • protection of confidential configuration data • Protection level: Write protection	60 °C -30 °C; No condensation 50 °C  5 000 m; Restrictions for installation altitudes > 2 000 m, see manual  Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes Yes Yes Yes Yes Yes

programming / cycle time monitoring / header	
• lower limit	adjustable minimum cycle time
• upper limit	adjustable maximum cycle time
Dimensions	
Width	100 mm
Height	117 mm
Depth	75 mm
Weights	
Weight, approx.	265 g

last modified:

5/3/2023